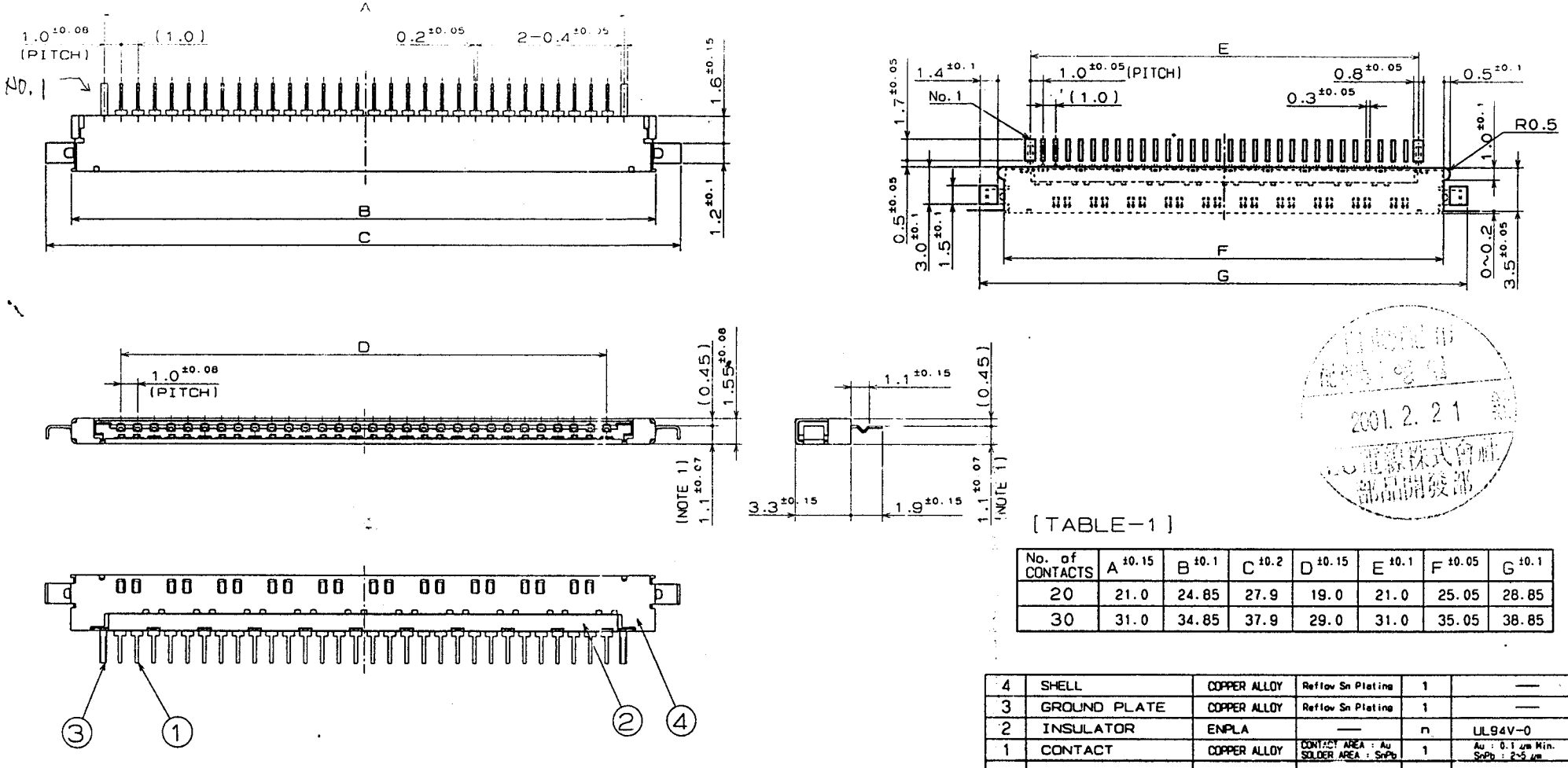
REV. No.	DATE	DCN No.	DESCRIPTION	DRAWN	DESIGNED	CHECKED	APPROVED

DWG. No. GUS111074

PCB LAYOUT (S=3/1, REFERENCE)



2001. 2. 21

[TABLE-1]

No. of CONTACTS	A ±0.15	B ±0.1	C ±0.2	D ±0.15	E ±0.1	F ±0.05	G ±0.1
20	21.0	24.85	27.9	19.0	21.0	25.05	28.85
30	31.0	34.85	37.9	29.0	31.0	35.05	38.85

ITEM	DESCRIPTION	MATERIAL	FINISH	Q'TY	REMARKS
4	SHELL	COPPER ALLOY	Reflow Sn Plating	1	—
3	GROUND PLATE	COPPER ALLOY	Reflow Sn Plating	1	—
2	INSULATOR	ENPLA	—	n	UL94V-0
1	CONTACT	COPPER ALLOY	CONTACT AREA : Au SOLDER AREA : SnPb	1	Au : 0.1 μm Min. SnPb : 2~5 μm

NOTE) 1. CO-PLANARITY OF SOLDER TAIL
(CONTACT, GROUND PLATE, SHELL)
: 0.1mm Max.

DIMENSIONS ARE IN MILLIMETERS [INCHES]	REFERENCE DOCUMENT: LGC(25)-K-A1120	DATE: JAN. 03 2001	SCALE: 4/1	WT.	Q'TY
TOLERANCE ON DIMENSION: . ±0.4, .X ±0.2, .XX ±0.1, .XXX ± ANGLES: X. ±, X.X. ±	ASS'Y DWG. No.	DRAWN	TITLE: GT101-**S-HR11 (SOCKET CONNECTOR)		
	MATERIAL	DESIGNED: D.H.Kim			
	TREATMENT	CHECKED			
	FINISH	APPROVED	SERIES: GT101	SHEET: 1/2	

LG Cable
555, HOGYE-DONG, ANYANG-SHI
KYUNGGI-DO, 430-080, KOREA

DWG. No. GUS111074